



VQFN-HR - 1 mm max height

PLASTICQUADFLATPACK - NO LEAD



1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

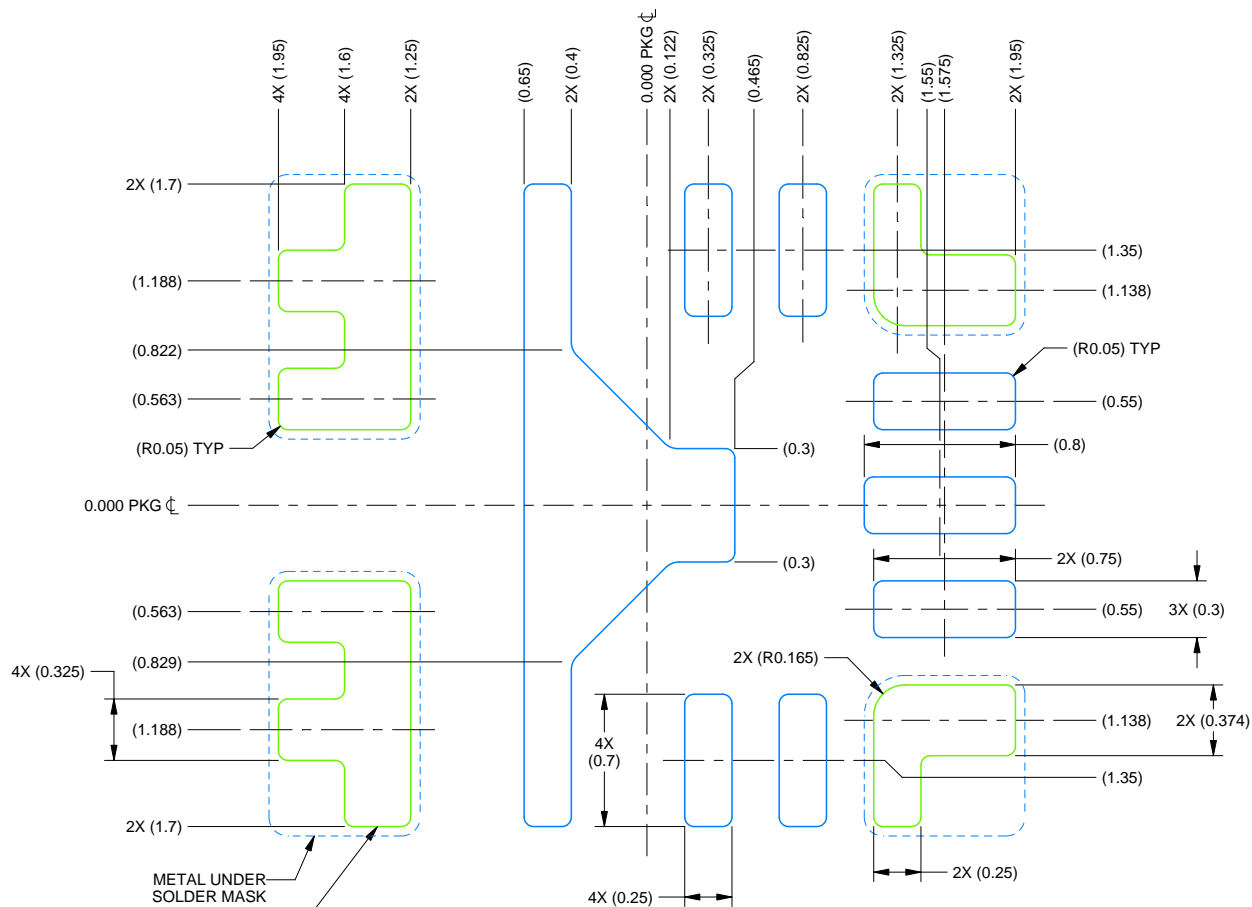
2. This drawing is subject to change without notice.

EXAMPLE BOARD LAYOUT

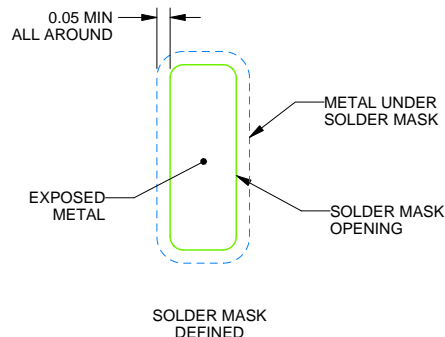
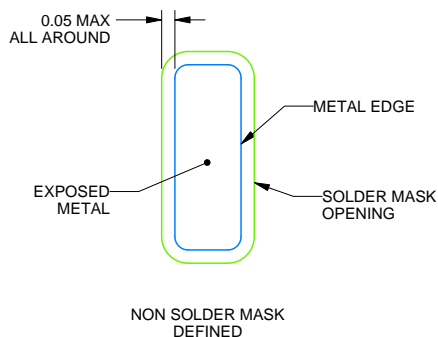
CHU0012A

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LAND PATTERN EXAMPLE
SCALE: 25X



SOLDER MASK DETAILS

4230710/A 05/2024

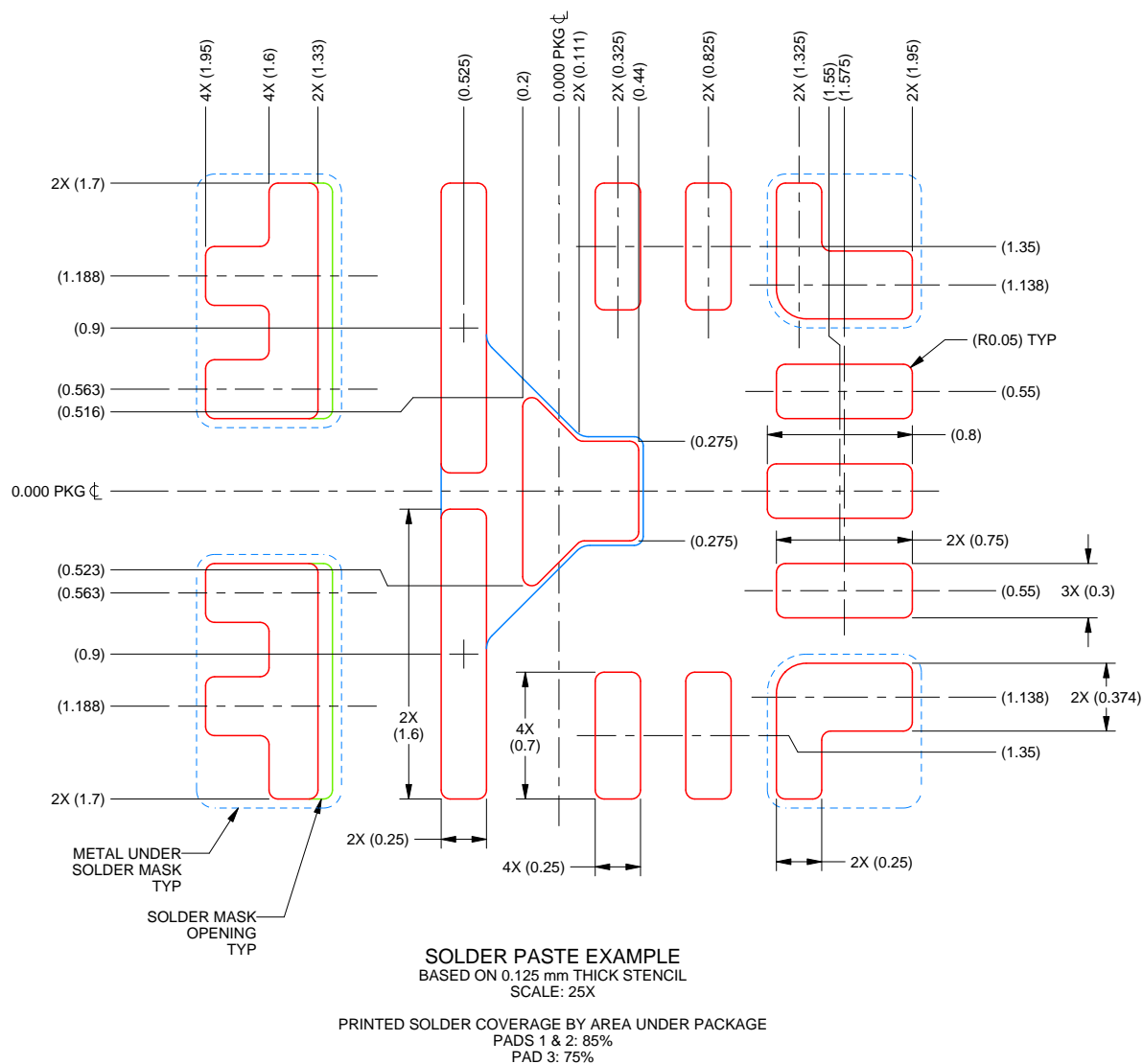
NOTES: (continued)

3. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/sluea271).

CHU0012A

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4230710/A 05/2024

NOTES: (continued)

4. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

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